



SPECIFICATION

| Customer: | | |
|-----------------------|----------------|---------|
| | | |
| | | Receipt |
| Item: | Crystal Unit | |
| Туре: | NX3225SA | |
| туре. | INAGEZGGA | — |
| Nominal Frequency: | 27.6 MHz | |
| Customer's Spec. No.: | | |
| NDK Spec. No.: | EXS00A-CS10286 | |
| | | |
| | | |

| | Revision Record | | | | | |
|------|-----------------|-------|----------|----------|---------|---------|
| Rev. | Date | Items | Contents | Approved | Checked | Drawn |
| | 17.Oct.2016 | Issue | | M.Sato | | R.Omomo |
| | | | | | | |
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1. Customer's Spec. No. :

2. NDK Spec. No. : EXS00A-CS10286

3. Type : NX3225SA

4. Electrical Specifications

| | Parameters | | Electrical Spec. | | |) . | Notes | |
|----|--|------------------|------------------|--------|----------------------|---------------------------|--|--|
| | i arameters | SYM. | min | typ | max | Units | Notes | |
| 1 | Nominal frequency | f_{nom} | | 27.6 | | MHz | | |
| 2 | Overtone order | - | Fui | ndamer | ntal | - | | |
| 3 | Frequency tolerance | - | -10 | 1 | +10 | × 10 ⁻⁶ | at +25°C | |
| | Frequency versus temperature characteristics | | -30 | - | +30 | ×10 ⁻⁶ | at -40~+85°C The reference temperature shall be +25°C | |
| 4 | | | -40 | - | +40 | ×10 ⁻⁶ | at -40~+105°C The reference temperature shall be +25°C | |
| | | | -50 | - | +50 | ×10 ⁻⁶ | at -40~+125°C The reference temperature shall be +25°C | |
| 5 | Equivalent resistance | - | - | - | 50 | Ω | IECπ-Network Series | |
| 6 | Load capacitance | C_L | - | 10 | - | pF | IECπ-Network | |
| 7 | Level of drive | - | - | 10 | 200 | μW | | |
| 8 | Insulation resistance | - | 500 | ı | - | МΩ | When terminal to terminal and terminal to cover were applied at DC100V ±15V. | |
| 9 | Operating temperature range | T_{opr} | -40 | - | +125 | °C | | |
| 10 | Storage temperature range | T _{str} | -40 | ı | +125 | °C | | |
| 11 | Air-tightness | - | - | - | 1.1×10 ⁻⁹ | Pa m³/s | Helium leak detector | |

5. Examination results document

Since a performance is guaranteed, an examination results document does not submit.

6. Application drawing

6.1 External dimension : EXD14B-00370 6.2 Taping and reel figure : EXK17B-00098 6.3 Holder marking : EXH11B-00317 6.4 Reliability assurance Item : EXS30B-00499 6.5 Recommendation reflow profile : EXS30B-00344

7. Notice

- 7.1 Order items are manufactured according to specification. As to conditions, which are not indicated in this specification and unpredictable such as applied condition and oscillation margin, please check them beforehand.
- 7.2 Unless we receive request for modification within 3 weeks from the issue date of this NDK specification sheet, we will supply products according to this specification. Also, if you'd like to modify specification of order, which has been placed with delivery request within 3 weeks from the issue data of this specification sheet, we would like to discuss with you separately.
- 7.3 In no event shall the company be liable for any product failure resulting from an inappropriate handling or operation of the product beyond the scope of its guarantee.
- 7.4 Where any change to the process condition is made due to the change(s) in the production line, inform personnel of the specifications.
- 7.5 Should this specification data give rise to any disputes relating to any intellectual property rights or any other rights of a third person, the company shall not indemnify anyone for any damage. Their disclosure must not be construed as the grant of a license to use any of the intellectual property rights owned by the company.
- 7.6 If you intend to use products listed on this specification for applications that may result in loss of life or assets (controls relating to safety, medical equipment, aeronautical equipment, space equipment, etc.), please do not fail to advise us of your intention beforehand.
- 7.7 In the company's production process whatever amount of ozone depleting substances (ODS) as specified in the Montreal protocol is not used.
- 7.8 Information contained in this specification must not be quoted, reproduced or used for other purposes including processing either in part or in full without obtaining prior approval from the company.
- 7.9 Crystal units will be damaged by ultrasonic welding process due to resonance of crystal wafer itself. NDK does not recommend using ultrasonic welding. If Ultra Sonic welding used, NDK strongly recommend verifying crystal unit damage by ultrasonic weld.
- 7.10 The appearance color and so on have a different case by purchasing it more than 2 suppliers of the component, but characteristic and reliability are guaranteed.
- 7.11 In case of the product long time keep at high temperature and humidity, may affect product characteristic (solder ability) and a packing condition.

Please keep at storage condition of temperature +5°C ~+35°C, humidity ~85%RH.

8. Prohibited items

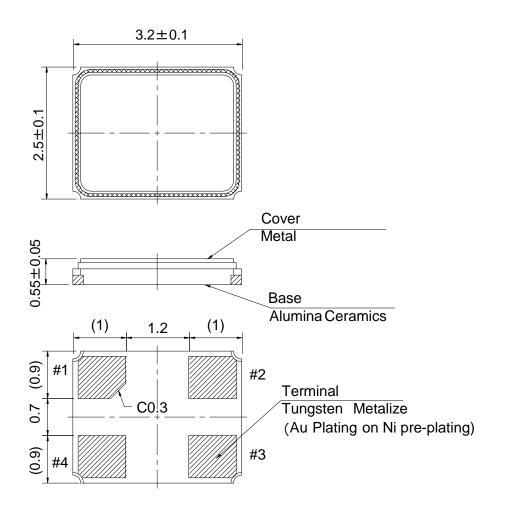
Be sure to use the product under the following conditions. Otherwise, the characteristics deterioration or destruction of the product may result.

(1) Reflow soldering heat resistance

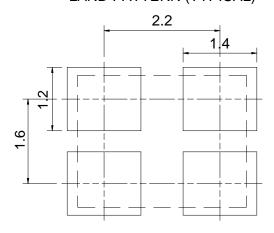
Peak temperature: 265°C, 10 sec Heating: 230°C or higher, 40 sec Preheating: 150°C to 180°C, 120 sec

Reflow passage times: twice
(2) Manual soldering heat resistance

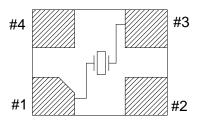
Pressing a soldering iron of 400°C on the terminal electrode for four seconds (twice).



LAND PATTERN (TYPICAL)

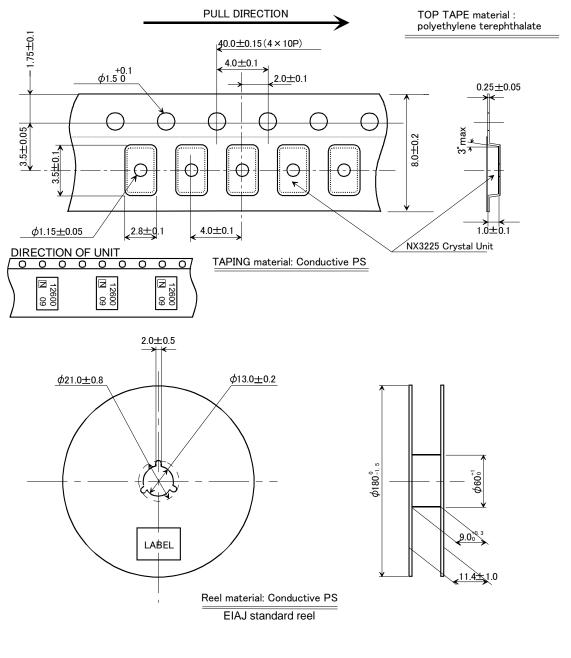


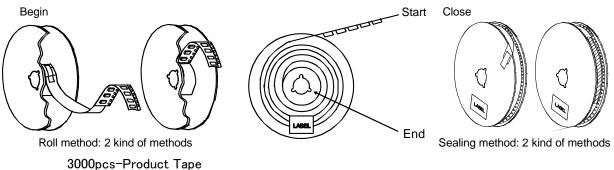
PIN CONNECTION (TOP VIEW)



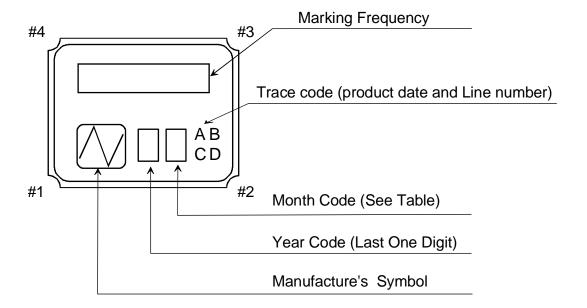
#2,#4: GND (CONNECTION COVER)

| | Da | te of Revise | Charge | Approved Reason | | | | |
|-----|--------|--------------|------------|------------------------|----------|-----------|--------------|------|
| Α | 4. | .Sep.2007 | R.Shariman | K.Kubota | Add Tole | rance. | | |
| | | Date | Name | Third Angle Projection | | Tolerance | Sc | ale |
| Dra | wn | 25.Oct.2005 | S.Mizusawa | Dimension: | mm | ±0.1 | - | / - |
| Des | signed | 25.Oct.2005 | S.Mizusawa | Title | | | | Rev. |
| Che | ecked | | | NX3225SA | | EVD4 | 4D 00270 | Α |
| App | oroved | 25.Oct.2005 | S.Mizusawa | Dimension Drawing | | g EXDIA | EXD14B-00370 | |





| | Dat | te of Revise | Charge | Approved Reason | | | | | |
|------|--------|--------------|-------------|---------------------------|--|---------------|--------------|------|----------|
| I | 22 | Aug. 2012 | T. Shimizu | K. Oguri | K. Oguri Top cover tape leader line was deleted. | | | | |
| | | Date | Name | Third Angle Projection To | | Tolerance | Sc | ale | |
| Drav | wn | 3.Sep.2001 | K.Oguri | Dimension:mm | | | | / | |
| Des | signed | 3.Sep.2001 | K.Oguri | Title | | Drawing No. | | Rev. | |
| Che | ecked | | | NX3225 Series | | EVI/47D 00000 | | | |
| App | roved | 3.Sep.2001 | K.Miyashita | Taping and Reel Spec. | | pec. | EXK17B-00098 | | |



NOTE

1. Frequency Code

Marking Frequency is consist of five digits, first five digits of Nominal Frequency

Example

| Nominal Frequency | 28.636363 MHz | | | |
|-------------------|---------------|--|--|--|
| Frequency Code | 28.636 | | | |

2. Month Code Table

| Month | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 | 12 |
|------------|------|------|------|------|------|------|------|------|------|------|------|------|
| | Jan. | Feb. | Mar. | Apr. | May. | Jun. | Jul. | Aug. | Sep. | Oct. | Nov. | Dec. |
| Month Code | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | X | Υ | Z |

^{*}Marking digits are not include a decimal point and dot mark.

| | Dat | e of Revise | Charge | Approved Reason | | | | |
|------|--------|-------------|------------|--|------------|-------------|--------|------|
| D | 19 | . Jun 2012 | H.Ouchi | M. Kubota Added terminal number informat | | ation. | | |
| | | Date | Name | Third Angle Projection To | | Tolerance | | ale |
| Drav | wn | 16.Jan.2006 | I.Miyahara | Dimension:mm | | | / | 1 |
| Des | signed | 16.Jan.2006 | I.Miyahara | Title | | Drawing No. | | Rev. |
| Che | ecked | 16.Jan.2006 | | Crystal Holder Marking | | EXH11B | 00247 | 7 |
| App | roved | 16.Jan.2006 | K.Okamoto | Crystal Holde | er warking | S EXPLIE | -00317 | D |

Reliability assurance item

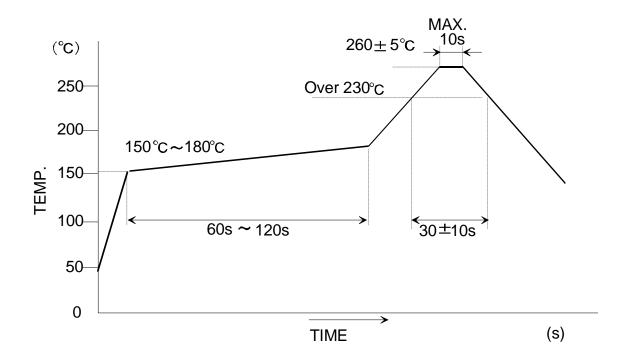
(page: 1/1)

| No. | Test Item | Test Methods | Specification Code |
|-----|-----------------------------|---|-----------------------|
| 1 | High Temperature Storage | +125±3°C 1000h | A,D |
| 2 | Low Temperature Storage | -40±3°C 1000h | A,D |
| 3 | Temperature Humidity | +85±3°C 80~85%RH 1000h | A,D |
| 4 | Temperature Cycling | -55±5°C / +125±5°C It is 1000 cycles using 30 minutes each as 1 cycle. | A,D |
| 5 | Vibration | Frequency Range: 10~2000Hz Amplitude or Acceleration: 1.52mm or 196m/s² 1 cycle: 20 minutes Test time: Three mutually perpendicular axes each 4 hours. | B,D |
| 6 | Shock | Devices are shocked to half sine wave (49000m/s ² , 0.15msec) six mutually perpendicular axis each 1 times. | B,D |
| 7 | Drop | Devices are dropped from the height 75cm onto iron plate. Execution 3 times random drops. | B,D |
| 8 | Solderability | Pre-heat temperature: +150±10°C Pre-heat time: 60~120s When the temperature of the specimen is reached at +215±3°C, it shall be left for 30±1sec. Material: H63A (Silver 2~3%) Flux: Rosin resin methyl alcohol solvent (1:4) | С |
| 9 | Reflow resistance | Pre-heat temperature: +150~180°C Pre-heat time: 90±30s Heat temperature: more than +230°C Pre-heat time: less than 30s Peak temperature: +260±5°C Peak time: less than 10s | B,D |

| Specification code | Specification |
|--------------------|---|
| А | $\Delta f/f \le \pm 20$ ppm $\Delta CI/CI \le \pm 15$ % or 5 Ω make use larger value |
| В | $\Delta f/f \le \pm 10$ ppm $\Delta CI/CI \le \pm 15$ % or 5 Ω make use larger value |
| С | The electrodes should be covered by a new solder at least 90% of immersed area. |
| D | After testing unless cracking of materials view of eyes and unless break of seal. |

Recommendation reflow condition

1.IR reflow condition



Form M-3

X-ON Electronics

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Click to view similar products for Crystals category:

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Other Similar products are found below:

CX3225GB25000M0PPSZ1 718-13.2-1 7A-40.000MAAE-T FL2000085 99-BU 9B-15.360MBBK-B 9C-7.680MBBK-T H10S-12.000-18-EXT-TR ABC2-6.000MHZ-D4Z-T ABLS-20.000MHZ-D2-T ABS071-32.768KHZ-6-T R38-32.768-12.5-5PPM-NPB BTD1062E05A-513 21U15A-21.4MHZ RTX-781DF1-S-20.950 LFXTAL066198Cutt 9C-14.31818MBBK-T A-11.000MHZ-27 ABL-27.000MHZ-B4Y-T ABM11-132-24.000MHZ-T3 ABM3B1-25.000MHZ-D2Y-T SPT2A-.032768B SPT2A.032768G LFXTAL065253Cutt LFXTAL066431Cutt XT9S20ANA14M7456 XT9SNLANA16M 7A-24.576MBBK-T 7B-30.000MBBK-T CX2520DB16000H0HPQCC MMCC2R32.7680KHZ 6504-202-1501 6526-202-1501 ABLS-12.000MHZ-B2Y-T 7A-10.000MBBK-T SG636PCE-20.000MC 3404 CM315D32768EZFT C1E-24.000-7-2020-R C1E-19.200-12-1530-X-R C1E-16.000-12-1530-X-R ABM11-16.000MHZ-9-B1U-T FL5000014 EUCA18-3.1872M FX0800015 425F35E027M0000 FP0800018 MS3V-T1R-32.768kHz-7pF-20PPM-TA-QC-Au VXM7-1C1-16M000 MS3V-T1R-32.768kHz-9pF-20PPM-TA-QC-Au